

C2824C393JBGACTU

Aliases (C2824C393JBGAC7800)

SMD Comm COG HV, Ceramic, 0.039 uF, 5%, 630 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 2824, 4.2 mm



Click [here](#) for the 3D model.

General Information

Series	SMD Comm COG HV
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	540 mg
Shelf Life	78 Weeks
MSL	1

Dimensions

Chip Size	2824
L	7.1mm +/-0.4mm
W	6.1mm +/-0.4mm
T	2.5mm +/-0.20mm
S	4.2mm MIN
B	1.27mm +/-0.4mm

Packaging Specifications

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	300

Specifications

Capacitance	0.039 uF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	5%
Voltage DC	630 VDC
Dielectric Withstanding Voltage	819 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	25.641 GOhms

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.